

# MOTOROLA

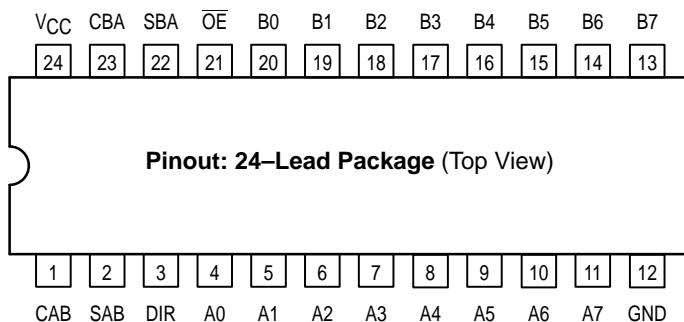
## SEMICONDUCTOR TECHNICAL DATA

### Low-Voltage Quiet CMOS Octal Transceiver/Registered Transceiver (3-State, Non-Inverting)

The MC74LVQ646 is a high performance, non-inverting octal transceiver/registered transceiver operating from a 2.7 to 3.6V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. The MC74LVQ646 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes from a LOW-to-HIGH logic level. Output Enable ( $\overline{OE}$ ) and DIR pins are provided to control the transceiver outputs. In the transceiver mode, data present at the high impedance port may be stored in either the A or the B register or in both. The select controls (SBA, SAB) can multiplex stored and real-time (transparent mode) data. The direction control (DIR) determines which bus will receive data when the enable  $\overline{OE}$  is active LOW. In the isolation mode ( $\overline{OE}$  HIGH), A data may be stored in the B register or B data may be stored in the A register. Only one of the two buses, A or B, may be driven at one time.

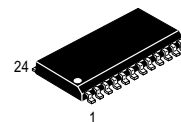
- Designed for 2.7 to 3.6V  $V_{CC}$  Operation – Ideal for Low Power/Low Noise Applications
- Guaranteed Simultaneous Switching Noise Level and Dynamic Threshold Performance
- Guaranteed Skew Specifications
- Guaranteed Incident Wave Switching into 75 $\Omega$
- Low Static Supply Current (10 $\mu$ A) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500mA
- ESD Performance: Human Body Model >2000V



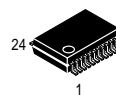
## MC74LVQ646

# LVQ

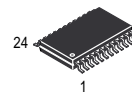
### LOW-VOLTAGE CMOS OCTAL TRANSCEIVER/ REGISTERED TRANSCEIVER



**DW SUFFIX**  
PLASTIC SOIC  
CASE 751E-04



**SD SUFFIX**  
PLASTIC SSOP  
CASE 940D-03



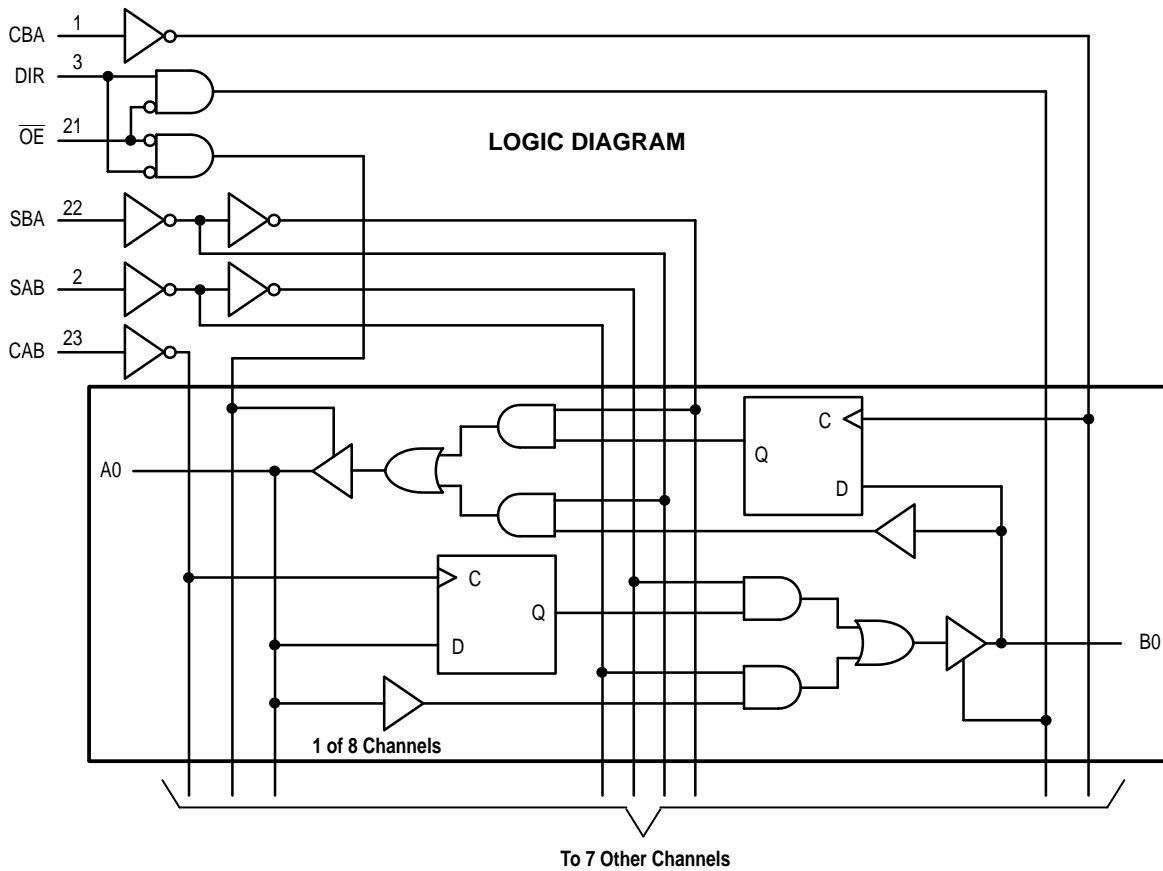
**DT SUFFIX**  
PLASTIC TSSOP  
CASE 948H-01

#### PIN NAMES

Pins	Function
A0–A7	Side A Inputs/Outputs
B0–B7	Side B Inputs/Outputs
CAB, CBA	Clock Pulse Inputs
SAB, SBA	Select Control Inputs
DIR, OE	Output Enable Inputs



# MC74LVQ646



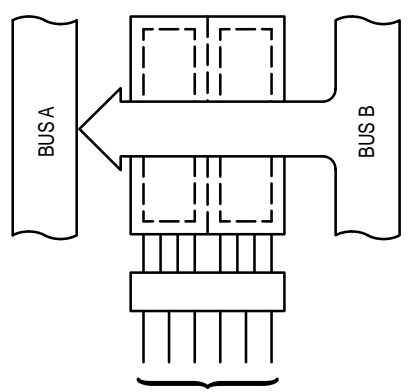
## FUNCTION TABLE

Inputs						Storage Registers		Data Ports		Operating Mode
OE	DIR	CAB	CBA	SAB	SBA	QA	QB	An	Bn	Operating Mode
H	X							Input	Input	
		⊕	⊕	X	X	NC	NC	X	X	Isolation, Hold Storage
		↑	↑	X	X	L H X X	X X L H	L H X X	X X L H	Store A and/or B Data
L	H							Input	Output	
		⊕	X*	L	X	NC NC	NC NC	L H	L H	Real Time A Data to B Bus
				H	X	NC	NC	X	QA	Stored A Data to B Bus
		↑	X*	L	X	L H	NC NC	L H	L H	Real Time A Data to B Bus; Store A Data
				H	X	L H	NC NC	L H	QA QA	Stored A Data to B Bus; Store A Data
L	L							Output	Input	
		X*	⊕	X	L	NC NC	NC NC	L H	L H	Real Time B Data to A Bus
				X	H	NC	NC	QB	X	Stored B Data to A Bus
		X*	↑	X	L	NC NC	L H	L H	L H	Real Time B Data to A Bus; Store B Data
				X	H	NC NC	L H	QB QB	L H	Stored B Data to A Bus; Store B Data

H = High Voltage Level; L = Low Voltage Level; X = Don't Care; ↑ = Low-to-High Clock Transition; ⊕ = NOT Low-to-High Clock Transition; NC = No Change; \* = The clocks are not internally gated with either the Output Enables or the Source Inputs. Therefore, data at the A or B ports may be clocked into the storage registers, at any time. For I<sub>CC</sub> reasons, Do Not Float Inputs.

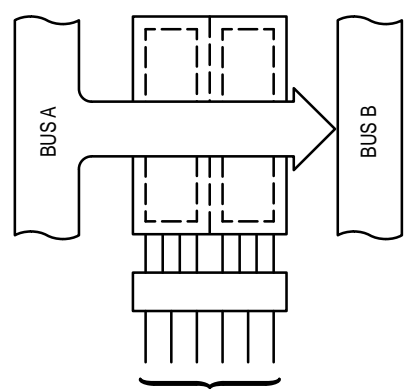
BUS APPLICATIONS

Real Time Transfer – Bus B to Bus A



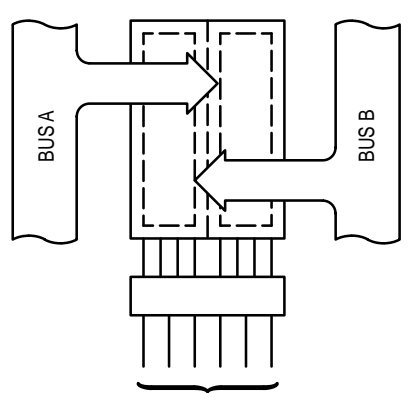
$\overline{OE}$	DIR	CAB	CBA	SAB	SBA
L	L	X	X	X	L

Real Time Transfer – Bus A to Bus B



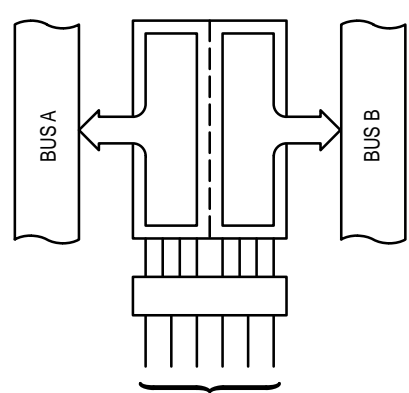
$\overline{OE}$	DIR	CAB	CBA	SAB	SBA
L	H	X	X	L	X

Store Data from Bus A, Bus B or Busses A and B



$\overline{OE}$	DIR	CAB	CBA	SAB	SBA
X	X	↑	X	X	X
X	X	X	↑	X	X
H	X	↑	↑	X	X

Transfer Storage Data to Bus A or Bus B



$\overline{OE}$	DIR	CAB	CBA	SAB	SBA
L	L	X	H or L	X	H
L	H	H or L	X	H	X

## MC74LVQ646

## ABSOLUTE MAXIMUM RATINGS\*

Symbol	Parameter	Value	Condition	Unit
V <sub>CC</sub>	DC Supply Voltage	-0.5 to +7.0		V
V <sub>I</sub>	DC Input Voltage	-0.5 ≤ V <sub>I</sub> ≤ V <sub>CC</sub> + 0.5V		V
V <sub>O</sub>	DC Output Voltage	-0.5 ≤ V <sub>O</sub> ≤ V <sub>CC</sub> + 0.5	Output in HIGH or LOW State	V
I <sub>IK</sub>	DC Input Diode Current	-20	V <sub>I</sub> = -0.5V	mA
		+20	V <sub>I</sub> = V <sub>CC</sub> + 0.5V	mA
I <sub>OK</sub>	DC Output Diode Current	-20	V <sub>O</sub> = -0.5V	mA
		+20	V <sub>I</sub> = V <sub>CC</sub> + 0.5V	mA
I <sub>O</sub>	DC Output Source/Sink Current	±50		mA
I <sub>CC</sub>	DC Supply Current	±400		mA
I <sub>GND</sub>	DC Ground Current	±400		mA
T <sub>STG</sub>	Storage Temperature Range	-65 to +150		°C

\* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V <sub>CC</sub>	Supply Voltage	2.0	3.3	3.6	V
V <sub>I</sub>	Input Voltage	0		V <sub>CC</sub>	V
V <sub>O</sub>	Output Voltage	0		V <sub>CC</sub>	V
T <sub>A</sub>	Operating Free-Air Temperature	-40		+85	°C
ΔV/Δt	Input Transition Rise or Fall Rate, V <sub>IN</sub> from 0.8V to 2.0V, V <sub>CC</sub> = 3.0V	0		125	mV/ns

## DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	T <sub>A</sub> = -40°C to +85°C		Unit
			Min	Max	
V <sub>IH</sub>	HIGH Level Input Voltage (Note 1)	2.7V ≤ V <sub>CC</sub> ≤ 3.6V, V <sub>O</sub> = 0.1V or V <sub>CC</sub> - 0.1V	2.0		V
V <sub>IL</sub>	LOW Level Input Voltage (Note 1)	2.7V ≤ V <sub>CC</sub> ≤ 3.6V, V <sub>O</sub> = 0.1V or V <sub>CC</sub> - 0.1V		0.8	V
V <sub>OH</sub>	HIGH Level Output Voltage	2.7V ≤ V <sub>CC</sub> ≤ 3.6V; I <sub>OH</sub> = -50μA	V <sub>CC</sub> - 0.1		V
		V <sub>CC</sub> = 2.7V; I <sub>OH</sub> = -12mA	2.2		
		V <sub>CC</sub> = 3.0V; I <sub>OH</sub> = -12mA	2.48		
V <sub>OL</sub>	LOW Level Output Voltage	2.7V ≤ V <sub>CC</sub> ≤ 3.6V; I <sub>OL</sub> = 50μA		0.1	V
		2.7V ≤ V <sub>CC</sub> ≤ 3.6V; I <sub>OL</sub> = 12mA		0.4	
I <sub>I</sub>	Input Leakage Current	2.7V ≤ V <sub>CC</sub> ≤ 3.6V; V <sub>I</sub> = V <sub>CC</sub> , GND		±1.0	μA
I <sub>OZT</sub>	Maximum I/O Leakage Current	V <sub>I</sub> (OE) = V <sub>IL</sub> , V <sub>IH</sub> ; V <sub>I</sub> , V <sub>O</sub> = V <sub>CC</sub> , GND		±3	μA
I <sub>OLD</sub>	Minimum Dynamic Output Current (Note 2)	V <sub>CC</sub> = 3.6V; V <sub>OLD</sub> = 0.8V Max		36	mA
I <sub>OHD</sub>		V <sub>CC</sub> = 3.6V; V <sub>OHD</sub> = 2.0V Min		-25	mA
I <sub>CC</sub>	Quiescent Supply Current	2.7V ≤ V <sub>CC</sub> ≤ 3.6V; V <sub>I</sub> = V <sub>CC</sub> , GND		10	μA

1. These values of V<sub>I</sub> are used to test DC electrical characteristics only. Functional test should use V<sub>IH</sub> ≥ 2.4V, V<sub>IL</sub> ≤ 0.5V.

2. Incident wave switching on transmission lines with impedances as low as 75Ω for commercial temperature range is guaranteed. Maximum test duration is 2ms, one output loaded at a time.

**DYNAMIC SWITCHING CHARACTERISTICS** ( $V_{CC} = 3.3V$ )

Symbol	Characteristic	Condition	$T_A = +25^\circ C$			Unit
			Min	Typ	Max	
$V_{OLP}$	Dynamic LOW Peak Voltage (Note 1)	$C_L = 50pF, V_{IH} = 3.3V, V_{IL} = 0V$		0.6	1.0	V
$V_{OLV}$	Dynamic LOW Valley Voltage (Note 1)	$C_L = 50pF, V_{IH} = 3.3V, V_{IL} = 0V$		-0.5	-1.0	V
$V_{IHD}$	High Level Dynamic Input Voltage (Note 2)	Input-Under-Test Switching 0V to Threshold, $f=1MHz$		1.5	2.0	V
$V_{ILD}$	Low Level Dynamic Input Voltage (Note 2)	Input-Under-Test Switching 3.3V to Threshold, $f=1MHz$		1.5	0.8	V

- Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW. The remaining output is measured in the LOW state.
- Number of data inputs is defined as "n" switching, "n-1" inputs switching 0V to 3.3V.

**AC CHARACTERISTICS<sup>1</sup>** ( $t_R = t_F = 2.5ns; C_L = 50pF; R_L = 500\Omega$ )

Symbol	Parameter	Limits									Unit
		$T_A = +25^\circ C$						$T_A = -40^\circ C$ to $+85^\circ C$			
		$V_{CC} = 3.0V$ to $3.6V$			$V_{CC} = 2.7V$			$V_{CC} = 3.0V$ to $3.6V$		$V_{CC} = 2.7V$	
		Min	Typ	Max	Min	Typ	Max	Min	Max	Max	
$f_{max}$	Clock Pulse Frequency	150						150			MHz
$t_{PLH}$ $t_{PHL}$	Propagation Delay Clock to Output	1.5 1.5	12.5 10.0	15.0 13.0	1.5 1.5	14.0 12.0	18.0 15.0	1.5 1.5	17.0 14.5	20.0 17.0	ns
$t_{PLH}$ $t_{PHL}$	Propagation Delay Input to Output	1.5 1.5	9.5 8.0	12.0 11.0	1.5 1.5	11.0 9.5	13.5 12.5	1.5 1.5	13.5 12.0	14.5 14.0	ns
$t_{PLH}$ $t_{PHL}$	Propagation Delay Select to Output	1.5 1.5	9.5 8.5	12.0 11.0	1.5 1.5	11.0 10.0	13.0 12.5	1.5 1.5	13.0 12.5	14.5 14.0	ns
$t_{PZH}$ $t_{PZL}$	Output Enable Time $\overline{OE}$ to An, Bn	1.5 1.5	8.0 9.0	10.5 11.0	1.5 1.5	9.5 10.0	12.0 12.5	1.5 1.5	11.0 12.0	13.0 14.0	ns
$t_{PHZ}$ $t_{PLZ}$	Output Disable Time $\overline{OE}$ to An, Bn	1.5 1.5	9.0 8.5	11.0 10.5	1.5 1.5	10.5 9.5	12.5 12.5	1.5 1.5	12.0 12.0	14.0 14.0	ns
$t_{PZH}$ $t_{PZL}$	Output Enable Time DIR to An, Bn	1.5 1.5	9.0 10.0	12.0 12.0	1.5 1.5	12.0 11.0	14.0 14.0	1.5 1.5	13.0 12.5	16.0 16.0	ns
$t_{PHZ}$ $t_{PLZ}$	Output Disable Time DIR to An, Bn	1.5 1.5	9.0 10.0	11.0 12.5	1.5 1.5	10.0 13.0	13.0 15.5	1.5 1.5	12.0 14.0	15.0 18.0	ns
$t_{OSHL}$ $t_{OSLH}$	Output-to-Output Skew (Note 2)		1.0 1.0	1.5 1.5			1.0 1.0	1.5 1.5	1.5 1.5		ns

- These AC parameters are preliminary and may be modified prior to release. The maximum AC limits are design targets. Actual performance will be specified upon completion of characterization.
- Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW ( $t_{OSHL}$ ) or LOW-to-HIGH ( $t_{OSLH}$ ); parameter guaranteed by design.

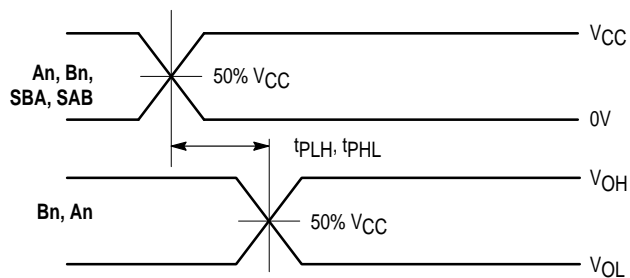
**AC OPERATING REQUIREMENTS** ( $t_R = t_F = 2.5ns; C_L = 50pF; R_L = 500\Omega$ )

Symbol	Parameter	Limits				Unit
		$T_A = +25^\circ C$		$T_A = -40^\circ C$ to $+85^\circ C$		
		$V_{CC} = 3.0V$ to $3.6V$		$V_{CC} = 2.7V$		
		Min	Min	Min	Min	
$t_s$	Setup Time, HIGH or LOW Dn to LE	2.5	4.0	2.5	4.5	ns
$t_h$	Hold Time, HIGH or LOW Dn to LE	1.5	1.5	1.5	1.5	ns
$t_w$	LE Pulse Width, HIGH	3.3	5.0	3.3	6.0	ns

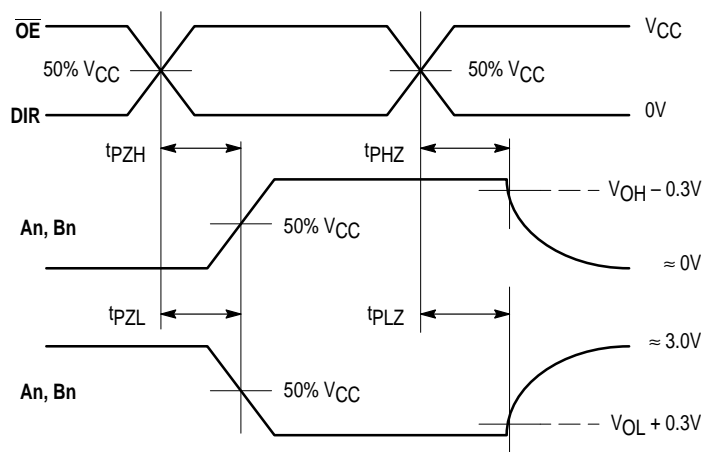
# MC74LVQ646

## CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C <sub>PD</sub>	Power Dissipation Capacitance	10MHz, V <sub>CC</sub> = 3.3V, V <sub>I</sub> = 0V or V <sub>CC</sub>	50	pF
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = Open, V <sub>I</sub> = 0V or V <sub>CC</sub>	4.5	pF
C <sub>I/O</sub>	Input/Output Capacitance	V <sub>CC</sub> = 3.3V, V <sub>I</sub> = 0V or V <sub>CC</sub>	15	pF

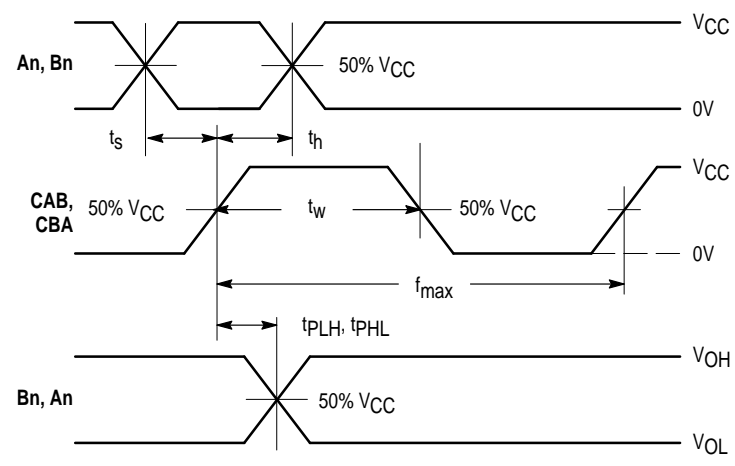


**WAVEFORM 1 – SAB to B and SBA to A, An to Bn PROPAGATION DELAYS**  
 $t_R = t_F = 2.5\text{ns}$ , 10% to 90%;  $f = 1\text{MHz}$ ;  $t_W = 500\text{ns}$



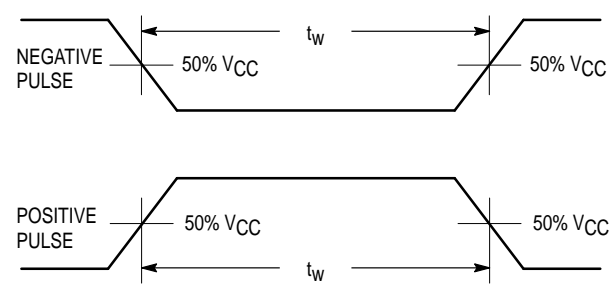
**WAVEFORM 2 – OE/DIR to An/Bn OUTPUT ENABLE AND DISABLE TIMES**  
 $t_R = t_F = 2.5\text{ns}$ , 10% to 90%;  $f = 1\text{MHz}$ ;  $t_W = 500\text{ns}$

**Figure 1. AC Waveforms**



**WAVEFORM 3 – CLOCK to Bn/An PROPAGATION DELAYS, CLOCK MINIMUM PULSE WIDTH, An/Bn to CLOCK SETUP AND HOLD TIMES**

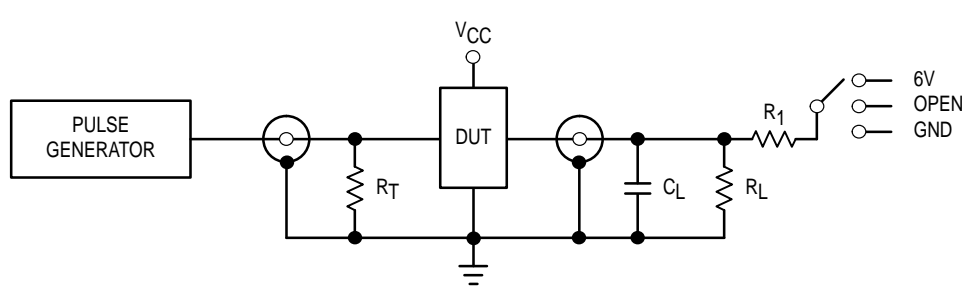
$t_R = t_F = 2.5ns$ , 10% to 90%;  $f = 1MHz$ ;  $t_W = 500ns$  except when noted



**WAVEFORM 4 – INPUT PULSE DEFINITION**

$t_R = t_F = 2.5ns$ , 10% to 90% of 0V to  $V_{CC}$

**Figure 2. AC Waveforms**



TEST	SWITCH
$t_{PLH}$ , $t_{PHL}$	Open
$t_{PZL}$ , $t_{PLZ}$	6V
Open Collector/Drain $t_{PLH}$ and $t_{PHL}$	6V
$t_{PZH}$ , $t_{PHZ}$	GND

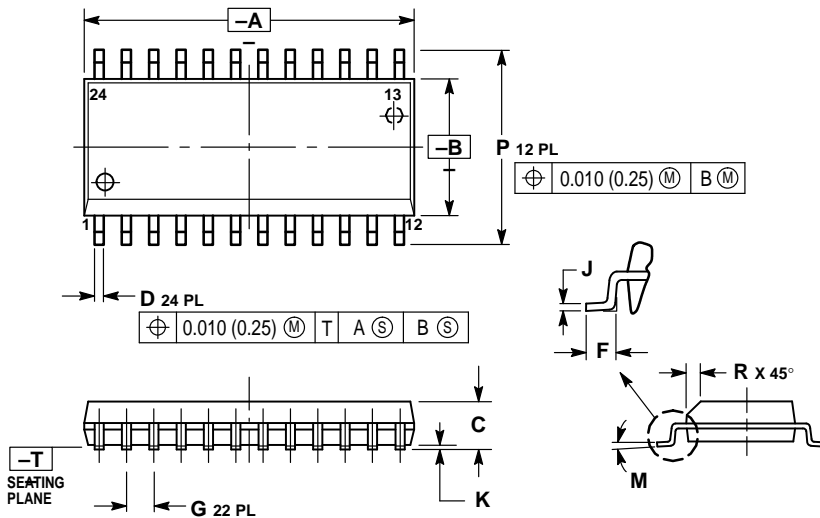
$C_L = 50pF$  or equivalent (Includes jig and probe capacitance)  
 $R_L = R_1 = 500\Omega$  or equivalent  
 $R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )

**Figure 3. Test Circuit**

MC74LVQ646

OUTLINE DIMENSIONS

DW SUFFIX  
PLASTIC SOIC PACKAGE  
CASE 751E-04  
ISSUE E

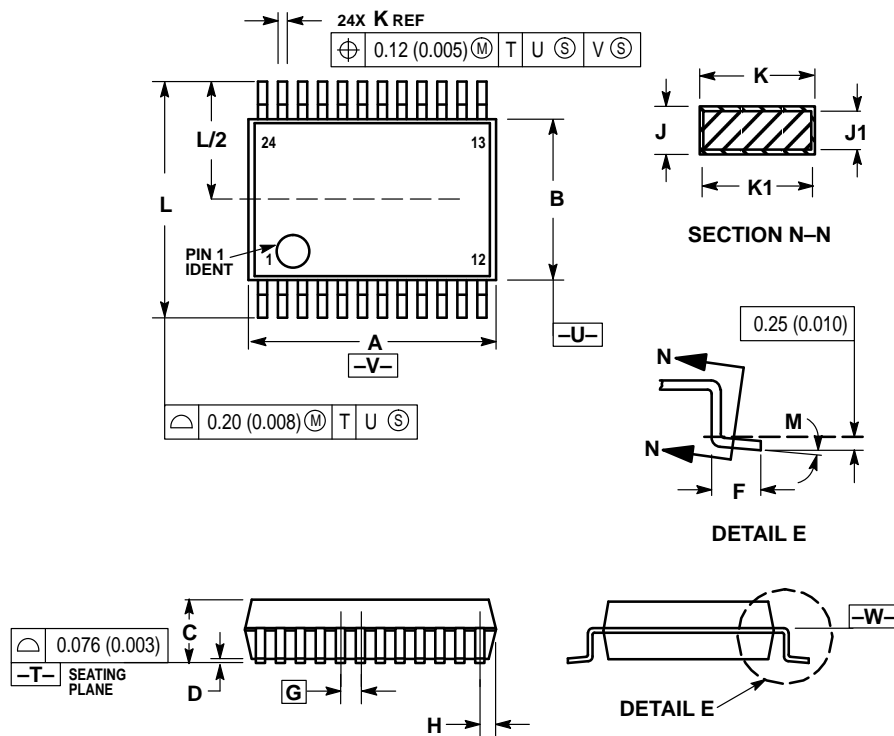


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.25	15.54	0.601	0.612
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.13	0.29	0.005	0.011
M	0°	8°	0°	8°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

SD SUFFIX  
PLASTIC SSOP PACKAGE  
CASE 940D-03  
ISSUE B



NOTES:

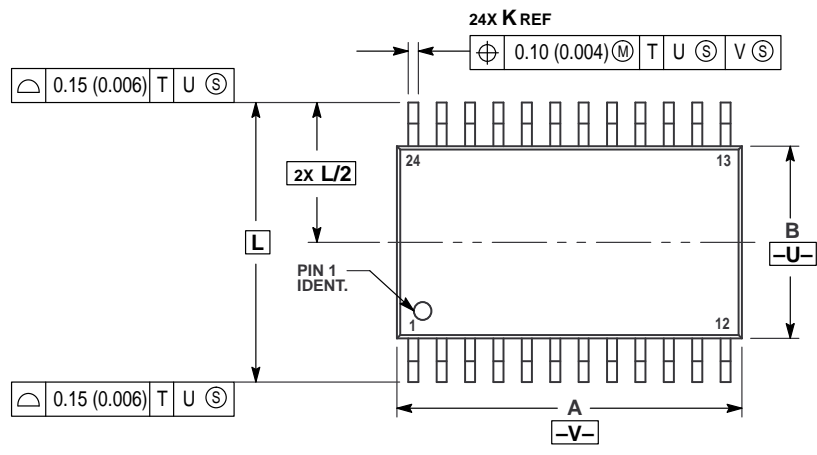
- 4 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 5 CONTROLLING DIMENSION: MILLIMETER.
- 6 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 7 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 8 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
- 9 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 10 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.07	8.33	0.317	0.328
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
H	0.44	0.60	0.017	0.024
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°



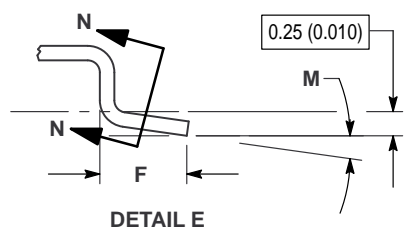
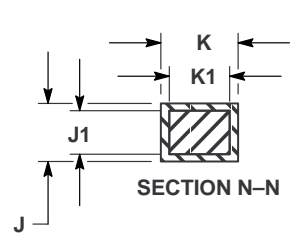
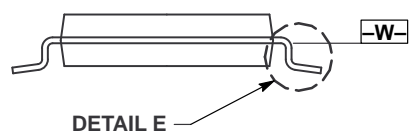
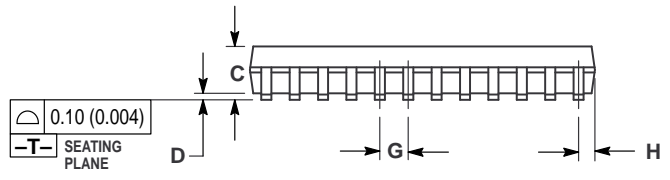
### OUTLINE DIMENSIONS

DT SUFFIX  
 PLASTIC TSSOP PACKAGE  
 CASE 948H-01  
 ISSUE O




- NOTES:
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - 2 CONTROLLING DIMENSION: MILLIMETER.
  - 3 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  - 4 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  - 5 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  - 6 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  - 7 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.70	7.90	0.303	0.311
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°



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